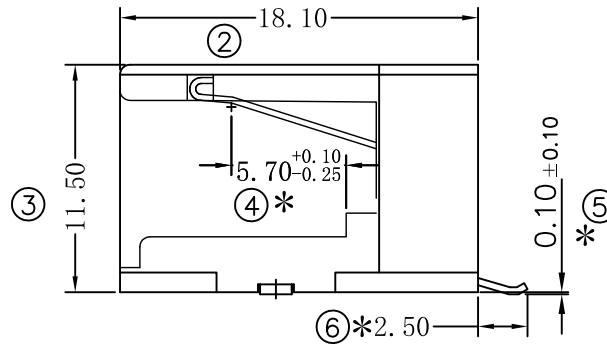
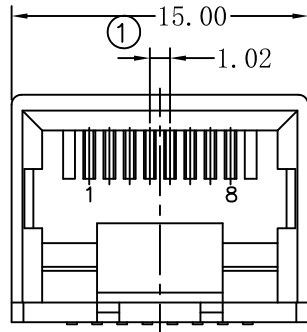


RoHS compliant



NOTES

MATERIAL

1. HOUSING MATERIAL : HIGH TEMP THERMOPLASTIC
FLAMMABILITY RATING UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE T=0.3mm.
3. PLATING : GOLD LATING OVER NICKEL IN CONTACT
TIN PLATING OVER NICKEL IN SOLDER AREA.
: FU", 3U", 6U", 15U", 30", 50".

ELECTRICAL

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 40 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 1000 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

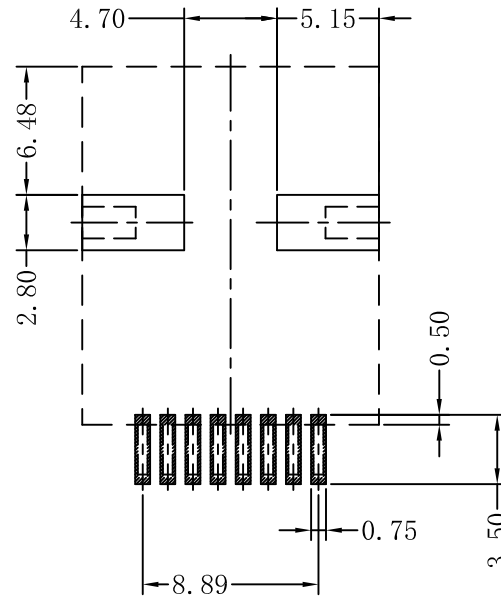
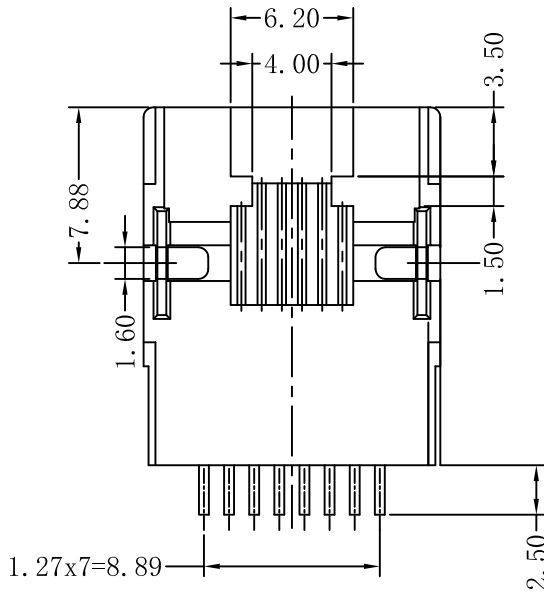
MECHANICAL

1. DURRABILITY : 750 CYCLES MIN.
2. PCB RETENTIONPRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C ~ +85°C.
2. OPERATION : -20°C TO 75°C.

Mates With Modular Plug Conforming To FCC Part 68, Subpart F.



PCB LAYOUT/TOP VIEW

P/N:RJ56S-8811-010551X

56S RJ45 90° SMT SERIES PCB JACK
POSITIONS (金針位置):
8-POSITIONS (8P)
CONTACTS (金針根數):
8-CONTACTS (8C)
PORTS (窗口):
1-1X1
SHIELD (屏蔽壳):
0-Without SHIELD (无屏蔽壳)
IRON PEG (铁脚定位脚):
1-PEG Inward (定位脚向内)
HOUSING PEG (塑胶定位柱):
0-Without PEG (无柱)

PACKING TYPE (包装):
1-BELL (卷带包装)
2-PVC TRAY (盘装)
COLOR (颜色):
1-BLACK (黑色)
7-BLUE (蓝色)
PLASTIC (塑料):
4-LCP; 5-PA9T
GOLD PLATING (鍍金厚度):
1-1U"; 5-6U"; 6-15U"
7-30U"; 8-50U";

				GENERAL TOLERANCE		DRAWN		Gene Li		2019/11/21		X-SHUN 东莞市祥舜电子科技有限公司 DONGGUAN X-SHUN ELECTRONIC TECHNOLOGY CO., LTD								
				.X	±0.35	X.°	± 2°	CHECKE		JCB										
A0		NEW DESIGN	2019/11/21		.XX	±0.25	X.°	± 1°	APPROVE				PART NO.		RJ56S-8811-010551X					
					.XXX	±0.15	.XX°	± 0.5°					TITLE:		RJ45 8P8C 90° SMT L=18.1MM PCB JACK					
REV	ECN NO	DESCRIPTION	DATE	SIGNATURE	PROJECT			UNIT		mm	SCALE	1:1	SHEET	1/1	REV	A0	DRAWING NO.		RJ56S-88	
																				